

U.S. PRO
10/02537
12/27/01

76024

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10026537	12/27/2001	257	1T	2811	S RAD

**APPLICANTS: Cho Ihl;

**CONTINUING DATA VERIFIED:

BEST AVAILABLE COPY

** FOREIGN APPLICATIONS VERIFIED:
REPUBLIC OF KOREA 2000-85583 12/29/2000

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	ATTORNEY DOCKET NO
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no			P 282974 HD-1077/US
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no			
Verified and Acknowledged Examiners's initials			
TITLE : Semiconductor device and method for fabricating a semiconductor device			
U.S. DEPT. OF COMM/PAT. & TM.-PTC-436L (Rev. 12-94)			

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

FILED WITH: ☐ DISK (CRF) ☐ CD-ROM
(Attached in pocket on right inside file)